



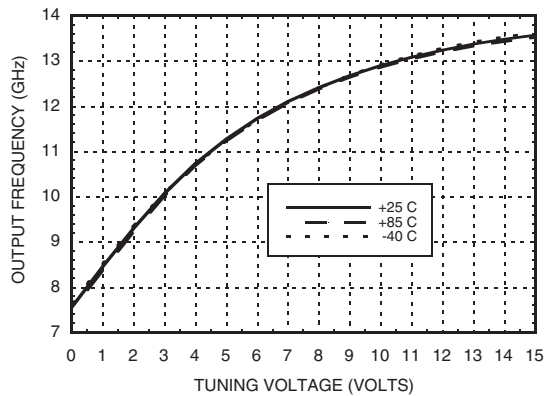
NO CONTENT ON THE ATTACHED DOCUMENT HAS CHANGED



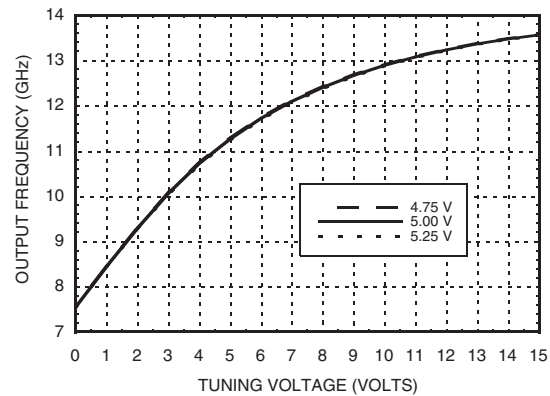
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WIDEBAND MMIC VCO w/ BUFFER AMPLIFIER, 8.0 - 12.5 GHz

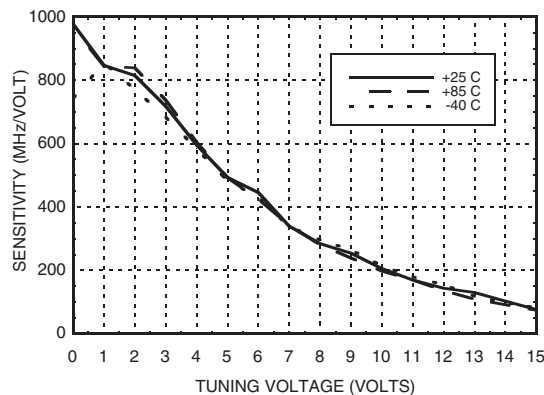
Frequency vs. Tuning Voltage, $V_{cc} = +5V$



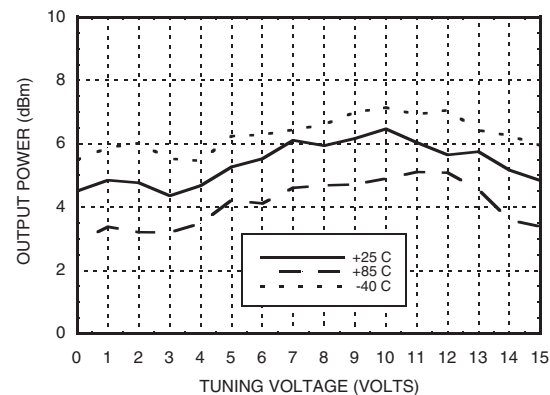
Frequency vs. Tuning Voltage, $T = +25 C$



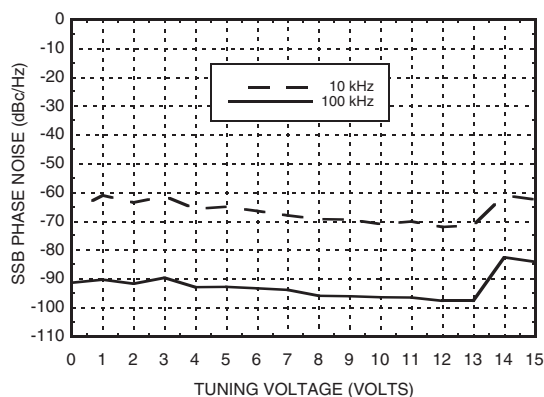
Sensitivity vs. Tuning Voltage, $V_{cc} = +5V$



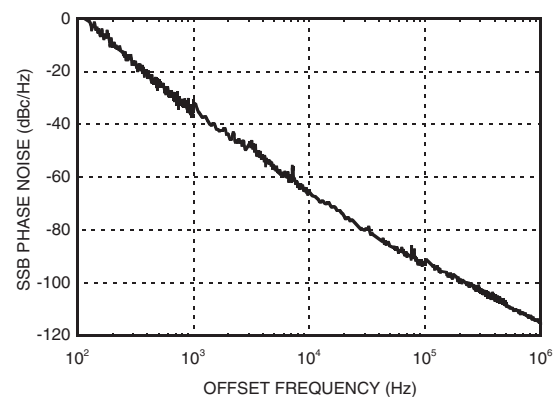
**Output Power vs.
Tuning Voltage, $V_{cc} = +5V$**



SSB Phase Noise vs. Tuning Voltage



Typical SSB Phase Noise @ $V_{tune} = +5V$



Absolute Maximum Ratings

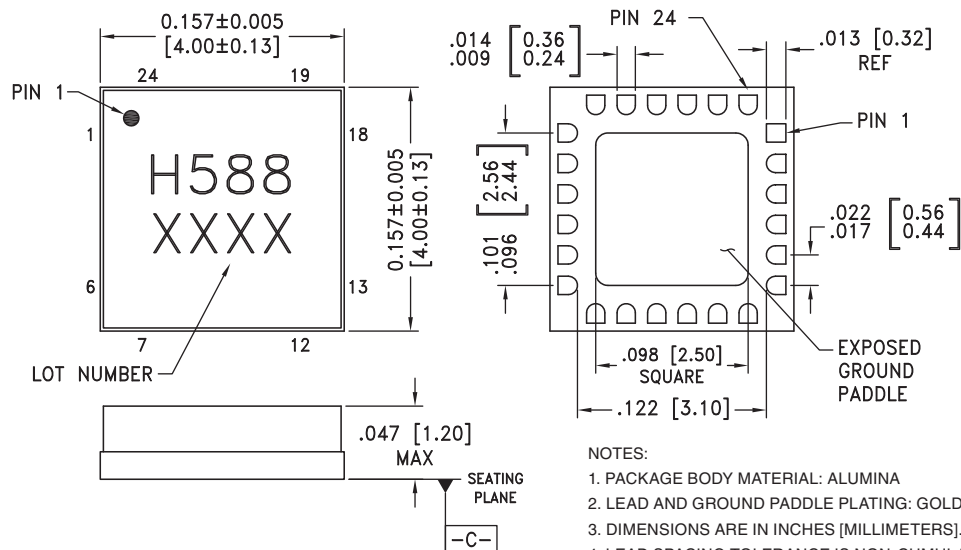
Vcc	+5.5 Vdc
Vtune	0 to +15V
Junction Temperature	135 °C
Continuous P _{diss} (T = 85°C) (derate 10.5 mW/°C above 85°C)	526 mW
Thermal Resistance (junction to ground paddle)	95 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A



**ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS**

Outline Drawing

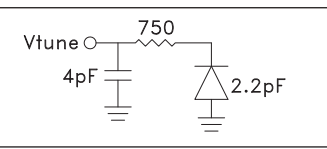
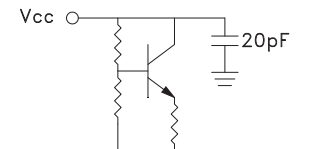
BOTTOM VIEW



NOTES:

1. PACKAGE BODY MATERIAL: ALUMINA
2. LEAD AND GROUND PADDLE PLATING: GOLD FLASH OVER NI.
3. DIMENSIONS ARE IN INCHES [MILLIMETERS].
4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
5. PACKAGE WARP SHALL NOT EXCEED 0.05mm DATUM -C-
6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.

Pin Descriptions

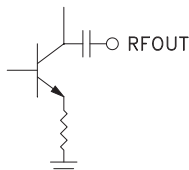
Pin Number	Function	Description	Interface Schematic
1 - 3, 5 - 11, 13, 17 - 24	N/C	No Connection. These pins may be connected to RF/DC ground. Performance will not be affected.	
4	Vtune	Control Voltage and Modulation Input. Modulation bandwidth dependent on drive source impedance. See "Determining the FM Bandwidth of a Wideband Varactor Tuned VCO" application note.	
12	Vcc	Supply Voltage Vcc= +5V	

For price, delivery and to place orders: Hittite Microwave Corporation, 20 Alpha Road, Chelmsford, MA 01824

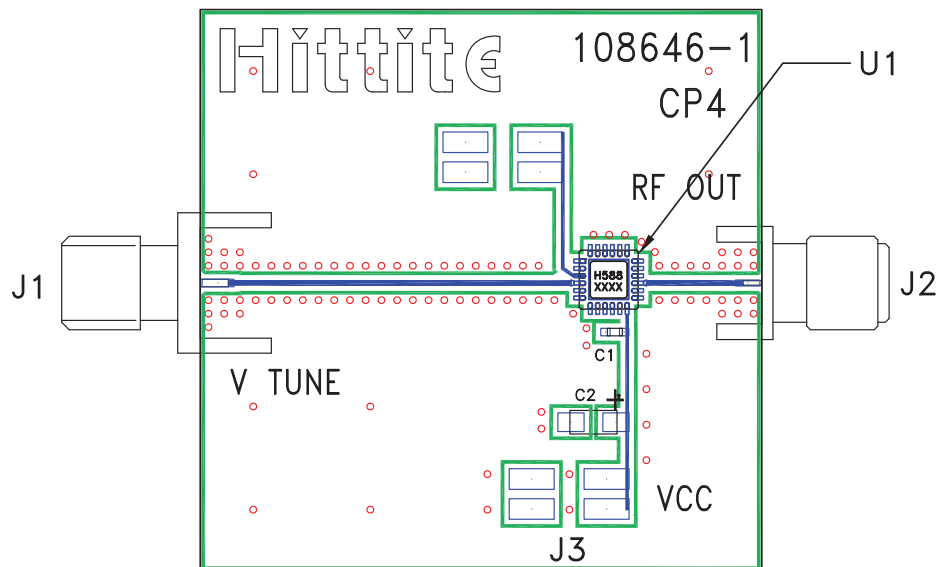
Phone: 978-250-3343 Fax: 978-250-3373 Order On-line at www.hittite.com

Application Support: Phone: 978-250-3343 or apps@hittite.com

Pin Descriptions

Pin Number	Function	Description	Interface Schematic
14, 16	GND	Package bottom has an exposed metal paddle that must also be RF & DC grounded.	
15	RFOUT	RF output (AC coupled)	

Evaluation PCB



List of Materials for Evaluation PCB 108648 ^[1]

Item	Description
J1	PCB Mount SMA RF Connector, Johnson
J2	PCB Mount SMA Connector, SRI
J3	DC Header
C1	1000 pF Capacitor, 0402 Pkg.
C2	4.7 μ F Capacitor, Tantalum
U1	HMC588LC4B VCO
PCB [2]	108646 Eval Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed ground paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.